

PNP 500mA 30V General purpose transistors

Datasheet

## AEC-Q101 Qualified

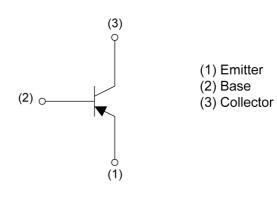
Parameter	Value
V <sub>CEO</sub>	-30V
Ι <sub>C</sub>	-0.5A

# • Outline SOT-323 SC-70

## Features

- 1)General purpose.
- 2)Complementary NPN types :
- 2SCR502U3 HZG
- 3)Collector current is large.
- 4)Low V<sub>CE(sat)</sub>.

## Inner circuit



## Application

LOW FREQUENCY AMPLIFIER

## Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
2SAR502U3HZG	SOT-323 (UMT3)	2021	TL	180	8	3000	LT

## ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

Parameter	Symbol	Values	Unit
Collector-base voltage	V <sub>CBO</sub>	-30	V
Collector-emitter voltage	V <sub>CEO</sub>	-30	V
Emitter-base voltage	V <sub>EBO</sub>	-6	V
	Ι <sub>C</sub>	-0.5	А
Collector current	I <sub>CP</sub> *2	-1	А
Base current	Ι <sub>Β</sub>	-0.15	А
Power dissipation	P <sub>D</sub> *3	200	mW
Junction temperature	Tj	150	°C
Range of storage temperature	T <sub>stg</sub>	-55 to +150	°C

## •Electrical characteristics ( $T_a = 25^{\circ}C$ )

Deremeter	Cumph al	Conditions	Values			Linit
Parameter	Symbol Conditions		Min.	Тур.	Max.	Unit
Collector-base breakdown voltage	$BV_{CBO}$	Ι <sub>C</sub> = -100μΑ	-30	-	-	V
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>C</sub> = -1mA	-30	-	-	V
Emitter-base breakdown voltage	BV <sub>EBO</sub>	Ι <sub>Ε</sub> = -100μΑ	-6	-	-	V
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = -25V	-	-	-200	nA
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = -4V	-	-	-200	nA
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = -200mA, I <sub>B</sub> = -10mA	-	-150	-400	mV
DC current gain	h <sub>FE</sub>	V <sub>CE</sub> = -2V, I <sub>C</sub> = -100mA	200	-	500	-
Transition frequency	f <sub>T</sub> *4	V <sub>CE</sub> = -10V, I <sub>E</sub> = 100mA, f = 100MHz	-	520	-	MHz
Output capacitance	C <sub>ob</sub>	V <sub>CB</sub> = -10V, I <sub>E</sub> = 0A, f = 1MHz	-	4	-	pF

\*1 Limited by power dissipation.

\*2 Pw=10ms, Single pulse.

\*3 Each terminal mounted on a reference land.

\*4 Pulsed



## • Electrical characteristic curves(T<sub>a</sub> = 25°C)

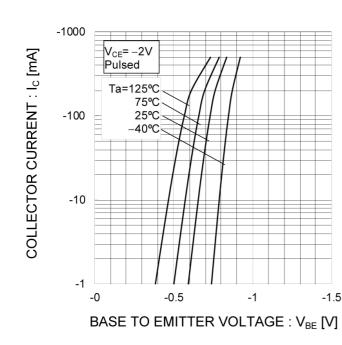
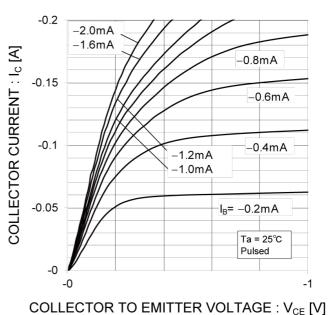


Fig.1 Grounded Emitter Propagation Characteristics

Fig.2 Typical Output Characteristics



vs. Collector Current(II)

Fig.4 DC Current Gain

Fig.3 DC Current Gain vs. Collector Current(I)

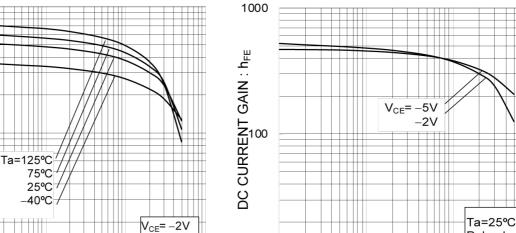
DC CURRENT GAIN : hFE

1000

100

10

-1



10

-1 -10 -100 -1000 COLLECTOR CURRENT : I<sub>c</sub> [mA]

-10

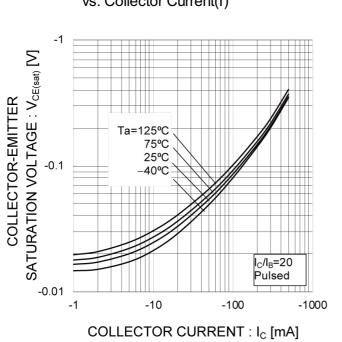
COLLECTOR CURRENT : Ic [mA]

-1000

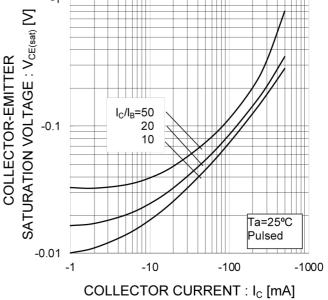
Pulsed

-100

## • Electrical characteristic curves ( $T_a = 25^{\circ}C$ )



# Fig.6 Collector-Emitter Saturation Voltage vs. Collector Current(II)



# Fig.5 Collector-Emitter Saturation Voltage vs. Collector Current(I)

Fig.7 Base-Emitter Saturation Voltage vs. Collector Current

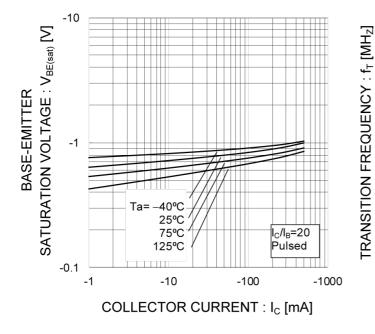
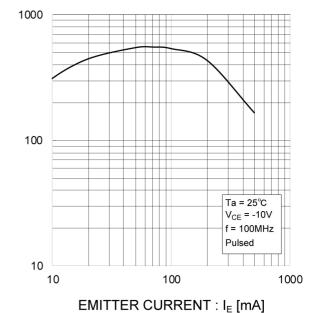


Fig.8 Gain Bandwidth Product vs. Emitter Current

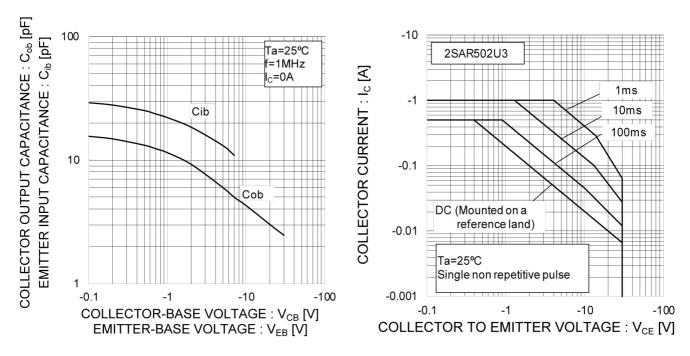


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## •Electrical characteristic curves(T<sub>a</sub> = 25°C)

Fig.9 Emitter input capacitance vs. Emitter-Base Voltage Collector output capacitance vs. Collector-Base Voltage

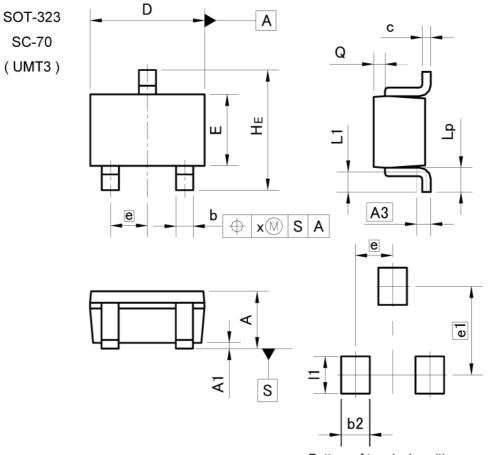


### Fig.10 Safe Operating Area



### 2SAR502U3HZG

### Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
А	0.80	1.00	0.031	0.039	
A1	0.00	0.10	0	0.004	
A3	0.2	25	0.0	D1	
b	0.25	0.40	0.01	0.016	
с	0.10	0.20	0.004	0.008	
D	1.90	2.10	0.075	0.083	
E	1.15	1.35	0.045	0.053	
е	0.0	65	0.03		
HE	2.00	2.20	0.079	0.087	
L1	0.20	0.50	0.008	0.02	
Lp	0.25	0.55	0.01	0.022	
Q	0.10	0.30	0.004	0.012	
х	_	0.10	-	0.004	

DIM	MILIMETERS		INCHES		
MIN		MAX	MIN	MAX	
e1	1.55		0.06		
b2	-	0.50	-	0.02	
1	-	0.65	-	0.026	

Dimension in mm/inches



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[b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure

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  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
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For details, please refer to ROHM Mounting specification

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